ABSOCIATION CONNECTING ELECTROMICS INDUSTRIES® International and P	IPC, Bannock	burn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar the declaratio	ration of n encon	f the substand npasses all lo	ces with wer leve	in the manufact el materials for	urer listed i which the n	tem. N nanufa	lote: if th cturer ha	e item is an as s engineering	sembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distribution				pe * Declaration Class * te Class 6 - RoHS Yes/No, Homogeneous Mate					erials and M	ials and Mfg Information				
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Respon	Response Date*					
nsemi												2024-05-20			
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com				
authorized Representative*	Title - Representative			Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards	Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Requester Item Number	Requester Item Number Mfr Ite		m Number Mfr Item Name			Effective Date Version Manufacturi		facturing Site	Weight*		ıt*	UOM	Unit Type		
	EMI814	1MUTAG	1Pair for HDMI			2024-05-20			MY1			2.4		mg	Each
Aanufacturing Proccess Inform	ation								- 1					1	I
Terminal Plating / Grid Array M	/aterial '	Terminal Base A	Alloy	J-STD-020 MSL Rati		Peak Process Body Tem		Body Tempera	ature Max Time at Peak		ık Temperat	Temperature Number of Reflo		of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С		30		nds	3		
omments															
vel 1 - maximum time at peak tempera	ture during so	dering is 10-3	0 seconds												
or more information regarding materia	l composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.18	mg	Supplier	Silicon (Si)	7440-21-3		0.18	mg
Die Attach	0.04	mg	Supplier	Epoxy resins	129915-35-1		0.014	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.026	mg
Lead Frame	0.82	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0012	mg
			Supplier	Silicon (Si)	7440-21-3		0.0053	mg
			В	Nickel (Ni)	7440-02-0		0.0246	mg
			Supplier	Copper (Cu)	7440-50-8		0.7888	mg
Mold Compound-Black	1.31	mg		Epoxy Phenol Resin	proprietary data		0.1375	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.1724	mg
Plating	0.02	mg	Supplier	Palladium (Pd)	7440-05-3		0.0015	mg
			В	Nickel (Ni)	7440-02-0		0.0182	mg
			Supplier	Gold (Au)	7440-57-5		0.0003	mg
Wire Bond - Au	0.03	mg	Supplier	Gold (Au)	7440-57-5		0.03	mg